



Designation: F1842 – 15

Standard Test Method for Determining Ink or Coating Adhesion on Flexible Substrates for a Membrane Switch or Printed Electronic Device¹

This standard is issued under the fixed designation F1842; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

1. Scope

1.1 This test method is based on existing Test Method **D3359**, with modifications to make it suitable for flexible substrates, printed electronic devices and membrane switches.

1.2 Despite the problems associated with a tape test on plastic substrates, it is our belief that this is still one of the best ways to test ink and coating for adhesion for membrane switch or printed electronic device applications. In writing this test method we are addressing several of the objections to the test method that could affect its precision and repeatability on plastic substrates.

1.3 These test methods cover whether the adhesion of coating or ink to a substrate is at an acceptable level. They do not distinguish between higher levels of adhesion, for which more sophisticated methods of measurement may be required.

NOTE 1—It should be recognized that differences in adherability of the ink or coating surface can affect the results obtained with inks or coatings having the same inherent adhesion.

1.4 In multi-coat systems adhesion failure may occur between coats, so that the adhesion of the coating system to the substrate is not determined.

1.5 This test method is specifically designed for measuring adhesion of inks and coatings (films) that have a thickness of 5 mil (125 microns) or less, on plastics such as polyester and polycarbonate.

1.6 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appro-*

¹ This practice is under the jurisdiction of ASTM Committee F01 on Electronics and is the direct responsibility of Subcommittee F01.18 on Printed Electronics.

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priate safety and health practices and determine the applicability of regulatory limitations prior to use.

2. Referenced Documents

2.1 *ASTM Standards:*²

D3359 Test Methods for Measuring Adhesion by Tape Test

3. Terminology

3.1 *membrane switch*—a momentary switching device in which at least one contact is on, or made of, a flexible substrate.

4. Summary of Test Method

4.1 A lattice pattern with six cuts in each direction is made in the ink or coating to the substrate. Pressure sensitive tape is applied over the lattice and then removed, and adhesion is evaluated by comparison with the descriptions and illustrations.

5. Significance and Use

5.1 If the ink or coating is to fulfill its function, it must adhere to the substrate. Substrates and their surface preparation have a significant effect on the adhesion of inks or coatings. Therefore, a method of evaluating adhesion of inks or coatings to different substrates or surface treatments, or of different inks or coatings to the same substrate and surface treatment, is useful to the industry.

5.2 The limitations of all adhesion methods and the specific limitation of this test method to lower levels of adhesion should be recognized before using it. The intra- and inter-laboratory precision of this test method is under evaluation.

5.3 Printing area to be tested should be a solid area large enough to include the entire cross hatch pattern.

² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.